# The Power of $[\mathcal{X}]$ 2013 Post Show Report<br/>March 19–21, 2013SNIEC, Shanghai, China

**China**2013



SOLARCON Ching2013

## **Top Attending Companies**

Visitors represent some of the region's leading semiconductor and technology companies, including:

- Semiconductor Manufacturing International (Shanghai) Corp.
- Shanghai Huali Microelectronics Corp.
- Shanghai Hua Hong NEC Electronics Co., Ltd.
- Shanghai Zhizhen International Travel Agency -Korea tours
- SK hynix Semiconductor (China) Ltd.
- Grace Semiconductor Manufacturing Corp.
- Shanghai Tianma Micro-Electronics, Ltd.
- HeJian Technology (Suzhou) Co., Ltd.
- Amkor Assembly & Test (Shanghai) Co., Ltd
- Shanghai Micro Electronics Equipment Co., Ltd.
- ASE Assembly & Test (Shanghai) Ltd.
- Hitech Semiconductor (Wuxi) Ltd.
- SanDisk Semiconductor (Shanghai) Co., Ltd.
- STATS ChipPAC (Shanghai) Co., Ltd.
- Advanced Semiconductor Manufacturing Co., Ltd.
- Applied Materials
- Kunshan VISIONOX Display Co., Ltd.
- Beijing NMC Co., Ltd.
- Advanced Micro-Fabrication Equipment Inc.
- FAIRCHILD Semiconductor (Suzhou) Ltd.
- Suzhou ASEN Semiconductors
- Taiwan Semiconductor Manufacturing Company Ltd.
- Huawei Technologies Co., Ltd.
- Beijing Sevenstar Electronics Co., Ltd.

SEMICON China, SOLARCON China, and FPD China attract the most qualified buying teams throughout China, representing the leading companies and major equipment OEMs.

# SEMICON® China, SOLARCON® China, FPD China

#### Key Numbers

Total Verified Attendance (not inc. SEMICON/SOLARCON/FPD China exhibitors)	45,523
Total Verified Attendance (inc. SEMICON/SOLARCON/FPD China exhibitors)	56,686
Total Verified Visitors	24,735
Total Verified Exhibitors	11,163
Total EP/Laser China Verified Visitors*	20,788
Total Exhibiting Areas (sq. m.)	26,395
Total Exhibiting Booths	2,943
Total Area Occupied (sq. m.)	73,200
VIP Attendance	631
Press Attendance	42
Number of Exhibiting Cos (inc. co-exhibitors)	1,092

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FPD China 2013

\* EP/Laser China 2013 were co-located events. Attendees had access to co-located exhibitions.

## Program Attendance 2013





# 2013 Post Show Report

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### March 19–21, 2013 SNIEC, Shanghai, China

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FPD China 2013

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Visitors' Primary Job Function 54% of visitors represent Engineering job functions.	<ul> <li>8% Executive Management/Board Member</li> <li>11% Mfg, Engineering/Operations Mgmt</li> <li>6% Product Management/Engineering</li> <li>6% Product Management/Engineering</li> <li>7% Design Engineering (incl, Software, Systems, Test, Hardware)</li> <li>12% Fabrication and Process Engineering</li> <li>5% Assembly/Packaging Engineering</li> <li>4% Quality Assurance and Test Engineering</li> <li>8% Research and Development Engineering</li> <li>8% Purchasing/Procurement</li> <li>1% Facilities Engineering/Engineering</li> </ul>	<section-header><text><text><text><text></text></text></text></text></section-header>
of visitors represent	<ul> <li>17% Marketing, Sales, Business Development</li> <li>4% Manufacturing and Production</li> <li>1% Environment, Health &amp; Safety</li> <li>1% 2000 - 100</li></ul>	<ul> <li>21% Final Decision Maker/ Co-Deciding/Crucial</li> <li>40% Recommend/Evaluate/Consult</li> <li>21% Specify</li> </ul>

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**China**2013

- 21% Specify
- 12% No Role
- 6% No Response/Not Applicable

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**Goverment/Public Policy** 

Human Resources Management

Financial/Industry Analyst Training

1%

1%

1%

4% 5%

12%

executive management and

board member job functions.

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VEAA

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SOLARCON





## **Visiting Company's Size**

• 1-99 Employees	31%
• 100-199 Employees	14%
• 200-499 Employees	12%
• 500-999 Employees	10%
• 1,000-9,999 Employees	20%
• >10,000 Employees	7%
• No Response/Not Applicable	6%

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# **Visiting Company's Main Product\***

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These are the visitors' main product area and the top categories in each segment.

\* Some visitors chose more than one segment therefore percentages will not add up to 100%.

PC/Consumer/Electronics Manufacturers	7%
Electronics Manufacturers Services (EMS) Provider	7%
Electronics Distributor/Reseller	5%
Semiconductor Device Manufacturers (IDM.foundry)	16%
MEMS/MST/Micromachines Manufacturers	2%
Flat Panel Display Manufacturer	4%
LED/Optoelectronics/Photonics Manufacturer	6%
Photovoltaic/PV Cells and Module Manufacturer	4%
Fabless Semiconductor Manufacturer/Design House	3%
Assembly &Test Services Providers	6%
Equipment Manufacturer	8%
Sub-systems/Components/Parts Manufacturer	3%
Material Suppliers	11%
Software - Electronic Design (EDA)/Silicon Intelectual Propoerty(IP)	2%
Software - Manufacturing/Factory Automation	2%
Manufacturing Products/Consumables	3%
Manufacturing Services and Consulting	2%
Professional Services and Consulting	2%
R & D/Academic/Professional Organizations and Institutions	3%
Media/Publishing	1%
Secondary Equipment and Services	1%
Construction/Construction Services	1%
Finance/Investment Products/Services	1%
Other	3%

## **Technology Areas or Segments**



Other



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# **Visiting Company's Main Areas Of Interest**

These are the visitors' main product area and the top categories in each segment.

\* Some visitors chose more than one segment therefore percentages will not add up to 100%.









#### 94% Semiconductor Manufacturing

Semiconductor Device Manufacturing (IDM, foundry)	40%	Fabless Semiconductor Manufacturer/ Design Services	14%
Electronic Manufacturing Services (EMS)	30%	Assembly and Test Services	16%

#### 91% Semiconductor Manufacturing Equipment

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Front-End/Device Manufacturing Equipment	22%
Thin Film Manufacturing Equipment	17%
Test Equipment	21%

# Assembly and Packaging Equipment19%Inspection & Measurement/Metrology15%Products0ther Equipment7%

14% 15%

5%

#### 77% Semiconductor Materials

Wafers and Substrates	22%	Test Materials
Process Materials	23%	Assembly & Packaging Materials
Chemicals & Solids	13%	Other Materials
Gases	9%	

#### 55% Software, Other Products and Services

Sub-Systems	8%
Components Parts & Accessories	20%
Factory Control Automation/Facilities	17%
Support Products(includes consumables)	9%
Secondary Equipment and Services	10%
Software-Manufacturing/Factory Automation	7%

Software-Electronic Design (EDA)/Silicon Intelectual Property(IP)	7%
Manufacturing Services or Consulting (incl.Those service or consulting directly related to Manufacturing)	11%
Business Services or Consulting	7%
Other	3%

#### 59% SOLAR/PV PRODUCTS

Photovoltaic cells and modules	18%
Photovoltaic production processes and technology	12%
Inverters	8%
PV concentrator cells	7%
Power plants,PV	7%
Photovoltaic components	6%
Tracking systems	3%
Solar facades,BLPV,roof elements	5%

#### 18% FPD

FPD Panels and Modules

Energy Storage	4%
Measurement and control technology	7%
Engineering,planning and consultation services	4%
Solar chargers and batteries	5%
Mounting systems	3%
Software,performance monitoring	3%
Solar research and development	5%
Consumer products	4%

FPD Components(drivers.module assembly etc.) 28%

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72%

